PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YI-CHING LIAO	03/09/2021
CHIH-YU CHEN	03/09/2021
YU HSUN HUNG	03/09/2021
JUEI CHIN SHEN	01/06/2021

RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORPORATION	
Street Address:	NO. 2, INNOVATION RD. II, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17693058

CORRESPONDENCE DATA

Fax Number: (949)250-3178

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9493872885

Email: ahong@wpatca.com

Correspondent Name: WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS

Address Line 1: 1100 QUAIL STREET, SUITE 202

Address Line 4: NEWPORT BEACH, CALIFORNIA 92660

ATTORNEY DOCKET NUMBER:	18506-2116
NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	03/11/2022

Total Attachments: 2

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507174325 PATENT REEL: 059246 FRAME: 0069

ASSIGNMENT

WHEREAS, I(we), LIAO, YI-CHING, CHEN, CHIH-YU, HUNG, YU HSUN and SHEN, JUEI CHIN whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

METHOD FOR CALIBRATING CURRENTS, CURRENT CONTROL SYSTEM, AND VOLTAGE CONTROL SYSTEM

<u></u>	INVENTION) for which an application for with unless at least one of the following is		ters Patent / Utility Pater
☐ United States Design			
☐ executed on:			
filed on:	Serial No.:		
☐ established by PCT I	nternational Patent Application No.:	filed:	designating the
United States of America			
☐ issued on	as U.S. Patent No.:		
WHEREAS. REALTEK S	EMICONDUCTOR CORPORATI	ON whose post	office address is NO.

INNOVATION RD. II, HSINCHU SCIENCE PARK, HSINCHU 30076, TAIWAN hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof, and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name LIAO, YI-CHING	Address NO. 2, INNOVATION RD. II, HSINCHU SCIENCE PARK, HSINCHU 30076, TAIWAN
Signature of Assignor (X) Liao, Yi-Ching	Date of Signature (X) 2021/03/09
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (optional)

PATENT

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T 4	Address
Assignor Name	
CHEN, CHIH-YU	NO. 2, INNOVATION RD. II, HSINCHU
	SCIENCE PARK, HSINCHU 30076, TAIWAN
Signature of Assignor	Date of Signature
Signature of Assignor	Date of Dignature
Cochen Chih-Yu	(\ddot{X}) 2021/03/09
	News of Witness (ontional)
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (optional)
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Assignor Name	Address
HUNG, YU HSUN	NO. 2, INNOVATION RD. II, HSINCHU
	SCIENCE PARK, HSINCHU 30076, TAIWAN
Signature of Assignor	Date of Signature
on H. Y. H	(X) 2021/03/09
(X) Hung. Yu Hsun	(A) 2021/00/03
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (optional)
bignature of winess (optional)	Signature of Winters (optional)
Assignor Name	Address
SHEN, JUEI CHIN	NO. 2, INNOVATION RD. II, HSINCHU
SHEAT, SOLI CHIII	
	SCIENCE PARK, HSINCHU 30076, TAIWAN
Signature of Assignor	Date of Signature
1 - 0 -1 . 0 -	1 - > > 1/1 / 1/1
(x) Shen Juei-Chin	$(x) >_0 >_1 / Jan / 06$
Name of Witness (optional)	Name of Witness (optional)
Traine of Training topinoming	- mile of miles (obvious)
Signature of Witness (optional)	Signature of Witness (optional)